

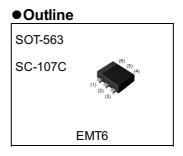
General purpose transistor (dual transistors)

<For Tr1(NPN)>

Parameter	Value
V _{CEO}	12V
Ι _C	500mA

<For Tr2(PNP)>

Parameter	Value	
V _{CEO}	-12V	
Ι _C	-500mA	

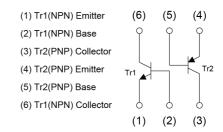


Features

- 1)Both a 2SA2018 chip and 2SC5585 chip in a EMT package.
- 2)Mounting possible with EMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4)Mounting cost and area can be cut in half.

5)Low V_{CE(sat)}

Inner circuit



Application

GENERAL PURPOSE SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMZ7	SOT-563 (EMT6)	1616	T2R	180	8	8000	Z7

•Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Tr1(NPN)	Tr2(PNP)	Unit
Collector-base voltage	V _{CBO}	15	-15	V
Collector-emitter voltage	V _{CEO}	12	-12	V
Emitter-base voltage	V _{EBO}	6	-6	V
Collector current	Ι _C	500	-500	mA
Collector current	I _{CP}	1	-1	А
Power dissipation	P _D ^{*1*2}	150		mW
Junction temperature	Tj	150		°C
Range of storage temperature	T _{stg}	-55 to +150		°C

•Electrical characteristics (T_a = 25°C) <For Tr1(NPN)>

Peremeter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV_{CBO}	Ι _C = 10μΑ	15	-	-	V	
Collector-emitter breakdown voltage	BV_{CEO}	I _C = 1mA	12	-	-	V	
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = 10μΑ	6	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = 15V	-	-	100	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 6V	-	-	100	nA	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 200mA, I _B = 10mA	-	90	250	mV	
DC current gain	h _{FE}	V _{CE} = 2V, I _C = 10mA	270	-	680	-	
Transition frequency	f _T	V _{CE} = 2V, I _E = -10mA, f = 100MHz	-	320	-	MHz	
Output capacitance	C _{ob}	V _{CB} = 10V, I _E = 0A, f = 1MHz	-	7.5	-	pF	

•Electrical characteristics (T_a = 25°C) <For Tr2(PNP)>

Deremeter	Cumph of	Conditions	Values			L locit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV_{CBO}	Ι _C = -10μΑ	-15	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-12	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = -10μΑ	-6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -15V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -6V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -200mA, I _B = -10mA	-	-100	-250	mV
DC current gain	h _{FE}	V _{CE} = -2V, I _C = -10mA	270	-	680	-
Transition frequency	f _⊤	V _{CE} = -2V, I _E = 10mA, f = 100MHz	-	260	-	MHz
Output capacitance	C _{ob}	V _{CB} = -10V, I _E = 0A, f = 1MHz	-	6.5	-	pF

*1 Each terminal mounted on a reference land.

*2 120mW per element must not be exceeded.



Electrical characteristic curves(T_a=25°C) <For Tr1(NPN)>

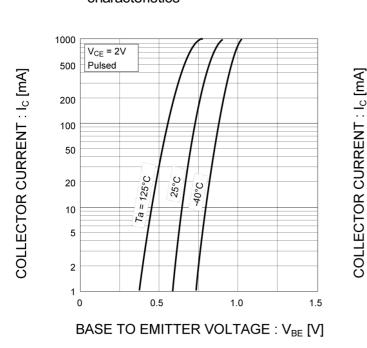


Fig.1 Grounded emitter propagation characteristics

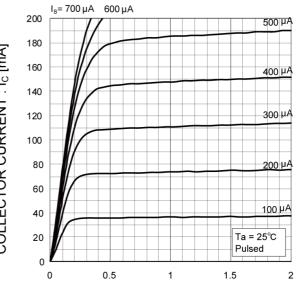
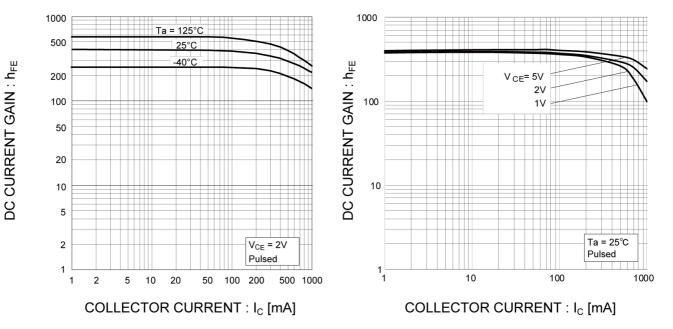


Fig.2 Typical output characteristics

COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.3 DC current gain vs. collector current (I)

Fig.4 DC current gain vs. collector current (II)





Electrical characteristic curves(T_a=25°C) <For Tr1(NPN)>

Fig.5 Collector-emitter saturation voltage

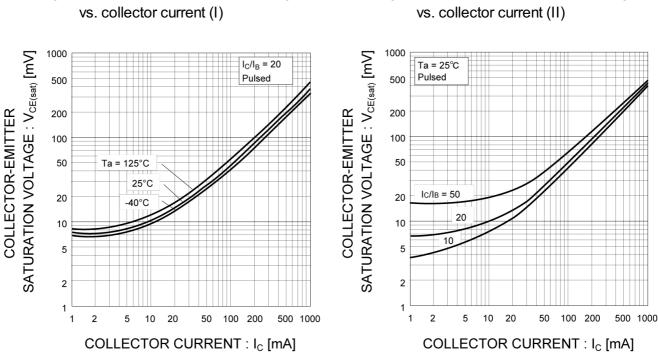


Fig.7 Base-emitter saturation voltage vs. collector current

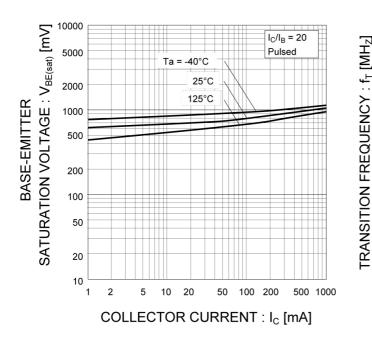


Fig.8 Gain bandwidth product vs. emitter current

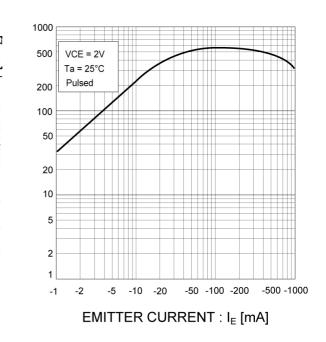
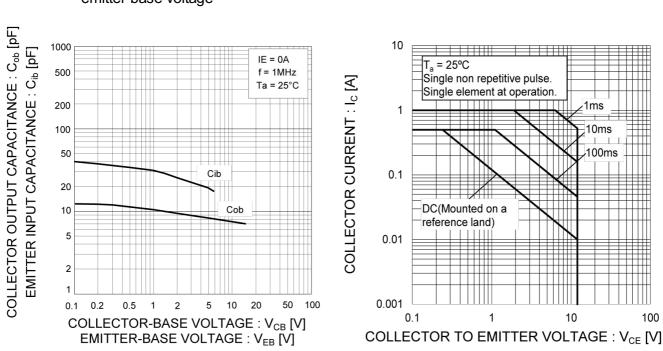


Fig.6 Collector-emitter saturation voltage vs. collector current (II)



Electrical characteristic curves(T_a=25°C) <For Tr1(NPN)>

Fig.9 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage Fig.10 Safe Operating Area



5/9





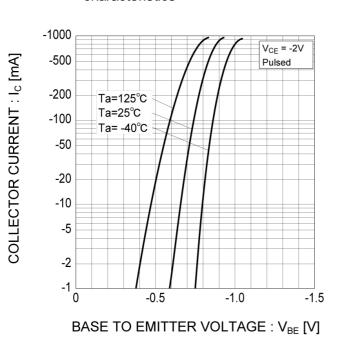
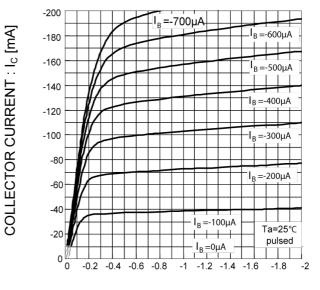


Fig.11 Grounded emitter propagation characteristics

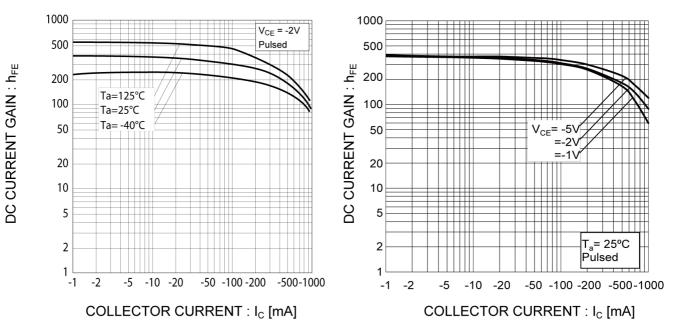
Fig.12 Typical output characteristics



COLLECTOR TO EMITTER VOLTAGE : $V_{\text{CE}}\left[V\right]$

Fig.13 DC current gain vs. collector current (I)

Fig.14 DC current gain vs. collector current (II)





•Electrical characteristic curves (T_a = 25°C) <For Tr2(PNP)>

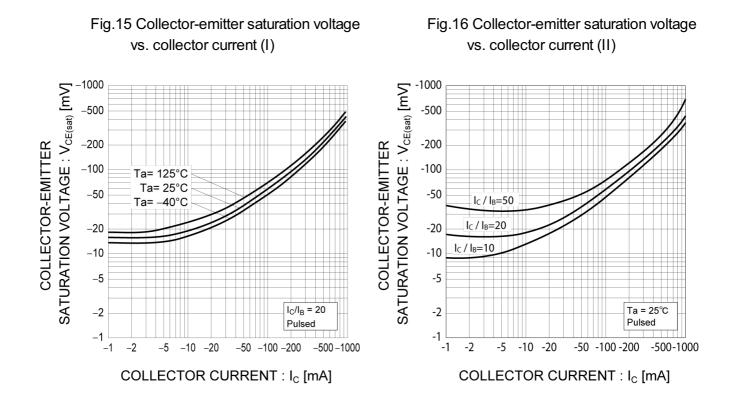


Fig.17 Base-emitter saturation voltage vs. collector current

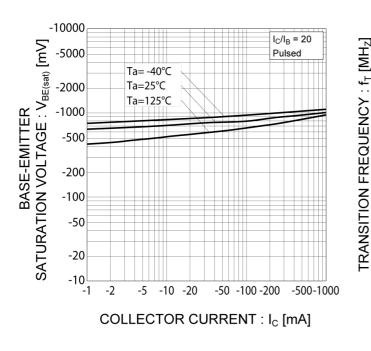
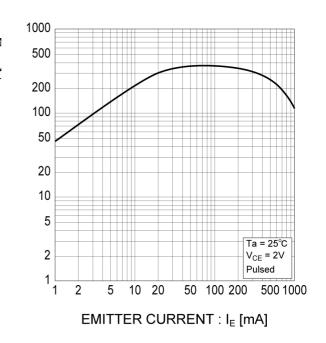
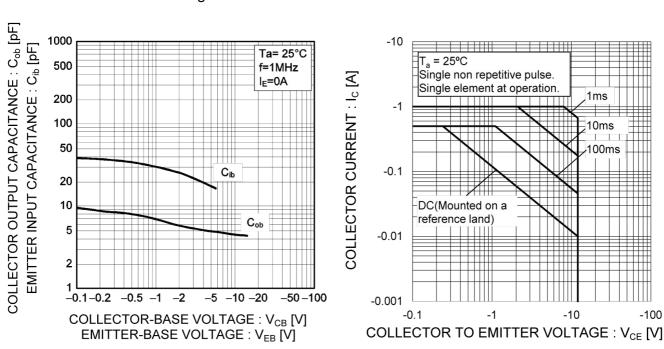


Fig.18 Gain bandwidth product vs. emitter current



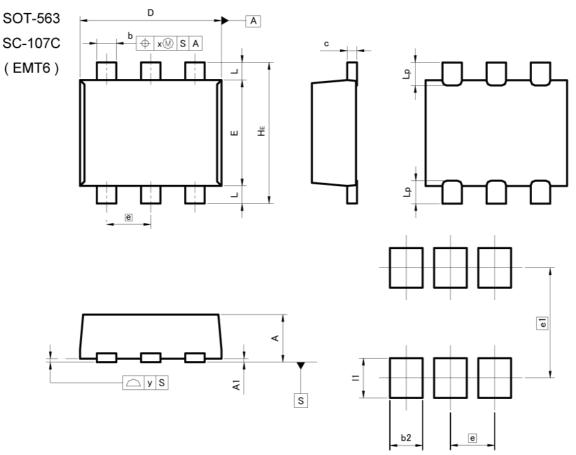
•Electrical characteristic curves(Ta=25°C) <For Tr2(PNP)>

Fig.19 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage Fig.20 Safe Operating Area





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
с	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.50		0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	-	0.35	-	0.014	
х	-	0.10	-	0.004	
У		0.10	-	0.004	
DIM	DIM MILIMETERS MIN MAX		INC	HES	
			MIN	MAX	
b2		0.37	-	0.015	
e1	1.	25	0.049		
- 11	-	0.45	-	0.018	

Dimension in mm/inches



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	CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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